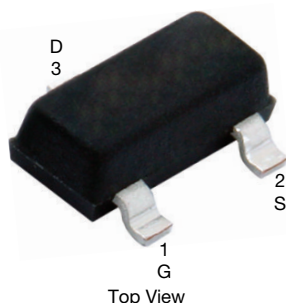


Automotive P-Channel 60 V (D-S) 175 °C MOSFET

SOT-23 (TO-236)


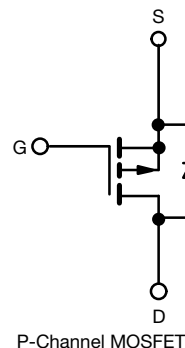
Top View

Marking Code: 9Wxxx

PRODUCT SUMMARY	
V_{DS} (V)	-60
$R_{DS(on)}$ (Ω) at $V_{GS} = -10$ V	0.177
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5$ V	0.246
I_D (A)	-2.8
Configuration	Single

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Material categorization:
for definitions of compliance please see
www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE


P-Channel MOSFET

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	SQ2361CES (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	-60	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current	$T_C = 25$ °C	I_D	-2.8	A
	$T_C = 125$ °C		-1.6	
Continuous source current (diode conduction)		I_S	-2.5	
Pulsed drain current ^a		I_{DM}	-11	
Single pulse avalanche current	$L = 0.1$ mH	I_{AS}	-12.5	
		E_{AS}	7.8	mJ
Maximum power dissipation	$T_C = 25$ °C	P_D	2	W
	$T_C = 125$ °C		0.67	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^b	R_{thJA}	175	°C/W
Junction-to-foot (drain)		R_{thJF}	75	

Notes

- a. Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %
b. When mounted on 1" square PCB (FR4 material)

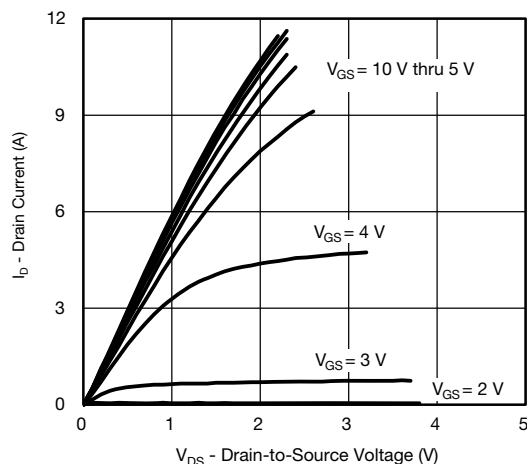
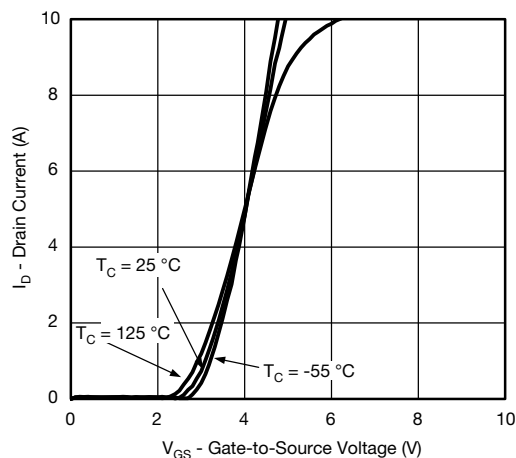
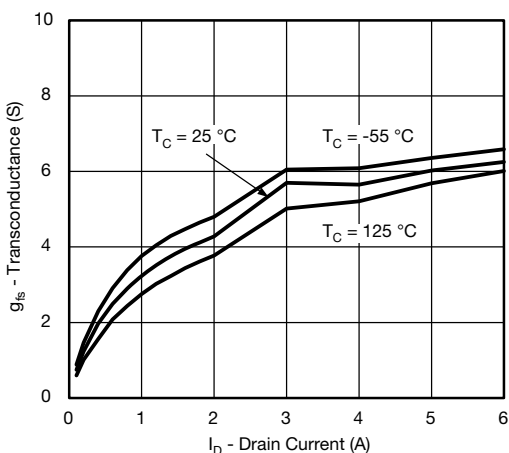
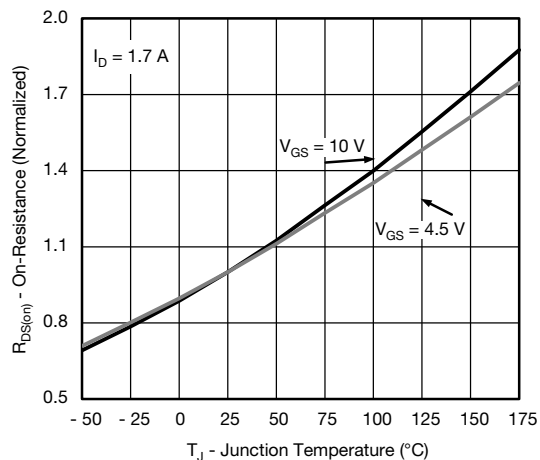
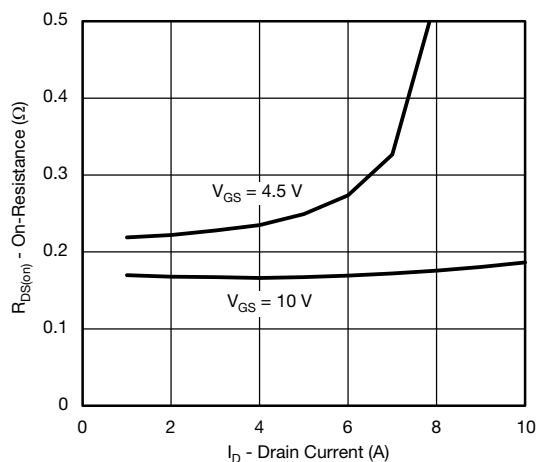
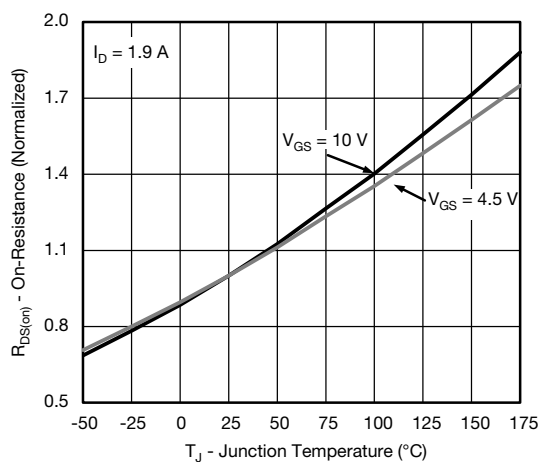


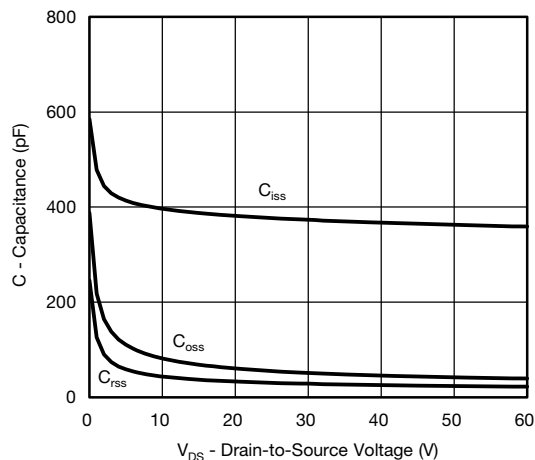
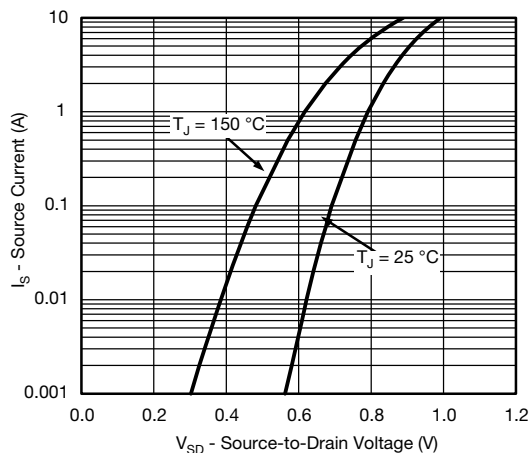
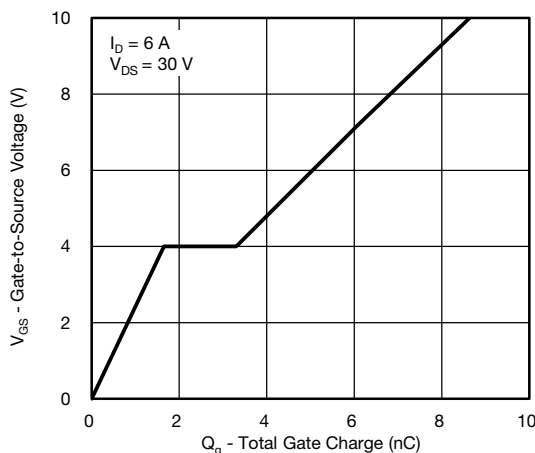
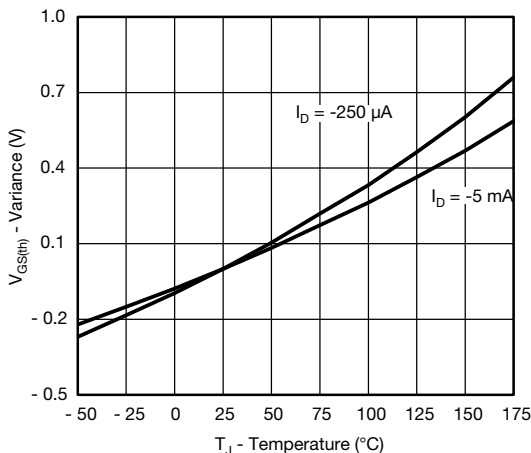
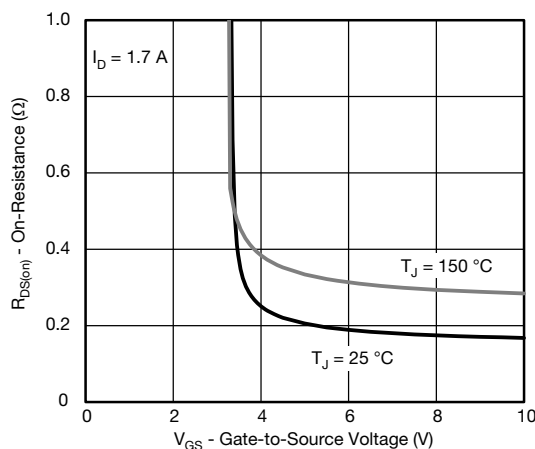
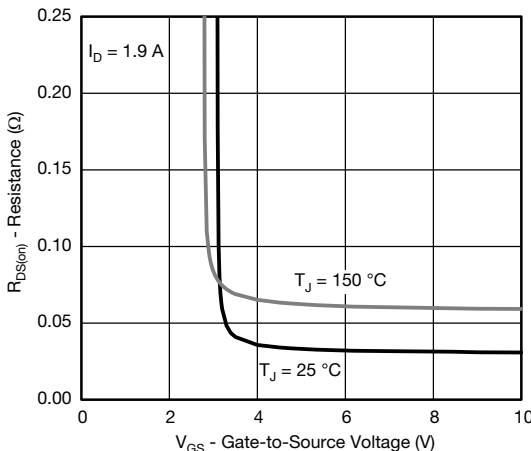
SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA		-60	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA		-1.5	-	-2.5	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V		-	-	± 100	
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = -60 V	-	-	-1	μA
		V _{GS} = 0 V	V _{DS} = -60 V, T _J = 125 °C	-	-	-50	
		V _{GS} = 0 V	V _{DS} = -60 V, T _J = 175 °C	-	-	-150	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	V _{DS} ≤ -5 V	-10	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	I _D = -2.4 A	-	0.130	0.177	Ω
		V _{GS} = -10 V	I _D = -2.4 A, T _J = 125 °C	-	-	0.310	
		V _{GS} = -10 V	I _D = -2.4 A, T _J = 175 °C	-	-	0.320	
		V _{GS} = -4.5 V	I _D = -1.8 A	-	0.205	0.246	
Forward transconductance ^b	g _{fs}	V _{DS} = -10 V, I _D = -2 A		-	5	-	S
Dynamic ^b							
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = -30 V, f = 1 MHz	-	380	550	pF
Output capacitance	C _{oss}			-	50	75	
Reverse transfer capacitance	C _{rss}			-	30	42	
Total gate charge ^c	Q _g	V _{GS} = -10 V	V _{DS} = -30 V, I _D = -6 A	-	9	12	nC
Gate-source charge ^c	Q _{gs}			-	1.6	-	
Gate-drain charge ^c	Q _{gd}			-	3.3	-	
Gate resistance	R _g	f = 1 MHz		2.1	4.1	8.1	Ω
Turn-on delay time ^c	t _{d(on)}	V _{DD} = -30 V, R _L = 20 Ω I _D ≅ -1.5 A, V _{GEN} = -10 V, R _g = 1 Ω		-	8	11	ns
Rise time ^c	t _r			-	9	12	
Turn-off delay time ^c	t _{d(off)}			-	22	26	
Fall time ^c	t _f			-	4	6	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed current ^a	I _{SM}			-	-	-11	A
Forward voltage	V _{SD}	I _F = -1.5 A, V _{GS} = 0 V		-	-0.9	-1.2	V
Body diode reverse recovery time	t _{rr}	I _F = -1.5 A, di/dt = 100 μs		-	23	46	ns
Body diode reverse recovery charge	Q _{rr}			-	25	50	nC
Reverse recovery fall time	t _a			-	20	-	ns
Reverse recovery rise time	t _b			-	3	-	
Body diode peak reserve recovery current	I _{RM(REC)}					-	-2.89

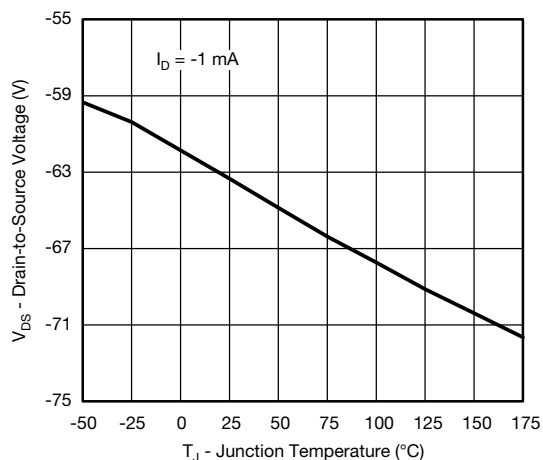
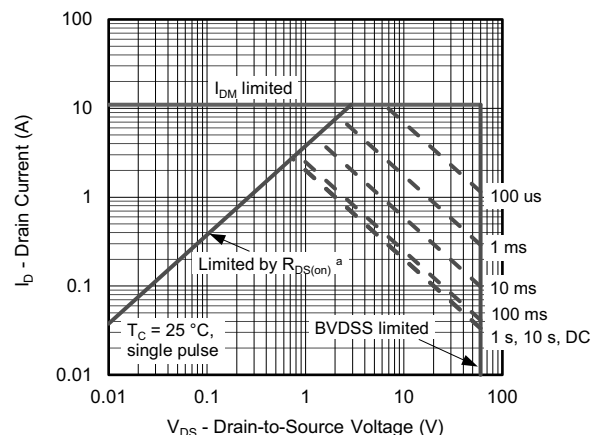
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

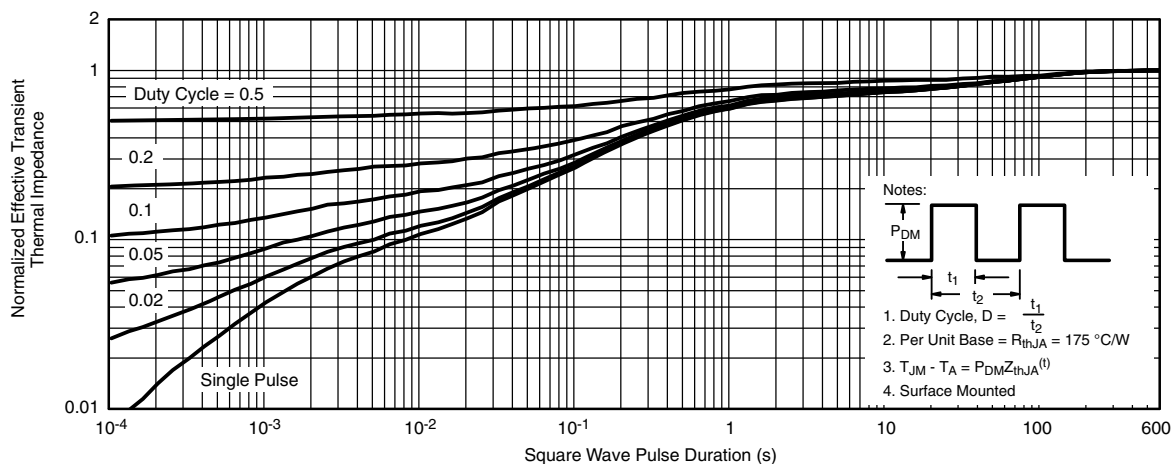
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Output Characteristics

Transfer Characteristics

Transconductance

On-Resistance vs. Junction Temperature

On-Resistance vs. Drain Current

On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Capacitance

Source-Drain Diode Forward Voltage

Gate Charge

Threshold Voltage

On-Resistance vs. Gate-Source Voltage

On-Resistance vs. Gate-Source Voltage

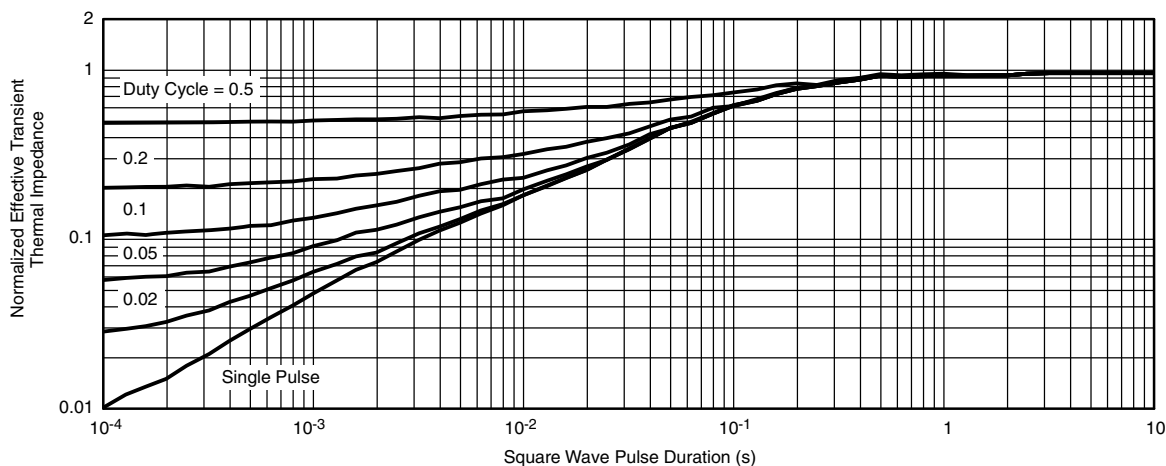
THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Drain-Source Breakdown vs. Junction Temperature


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area

Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^{\circ}\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Case ($25\text{ }^{\circ}\text{C}$)are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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